

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S40	217	(yuji near2 kamikawa).in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 13:21
S2	214	(yuji near2 kamikawa).in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 13:21
S41	39	(koji near2 egashira).in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 13:34
S1	38	(koji near2 egashira).in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 13:34
S44	48	S43 and (orifice or nozzle)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 13:35
S43	81	S42 and plate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 13:43
S45	58	S42 and plan	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:08
S46	18310	(tokyo and electron).as.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:09
S49	702	S48 and (nozzle or orifice)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:10
S48	2984	S47 and plate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:10

S50	346	S49 and ((nozzle or orifice) with (container or chamber or vessel))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:11
S51	246	S50 and (circular or cylindrical or cylinder)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:12
S52	196	S51 and ((semiconductor or wafer or substrate) with (hold\$3 or rotor\$ or rotat\$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:13
S42	241	S40 or S41	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:51
S33	135	(((((134/198,199,200,902.ccls. or 216/2,92.ccls.) or 156/345.21,345.51,345.54,345.55.ccls.) and @pd>"20020926") and (semiconductor or wafer or substrate)) and ((nozzle or spray\$3))) and (fan or plane or planar)) and (chamber or container or vessel or rotor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:58
S37	297	((134/198,199,200,902.ccls. or 216/2,92.ccls.) or 156/345.21,345.51,345.54,345.55.ccls.) and @pd>"20040128"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 14:59
S54	161	((134/198,199,200,902.ccls. or 216/2,92.ccls.) or (156/345.21,345.51,345.54,345.55.ccls.)) and @pd>"20040831"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:00
S53	5680	((134/198,199,200,902.ccls. or 216/2,92.ccls.) or (156/345.21,345.51,345.54,345.55.ccls.) and @pd>"20040831")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:00
S55	130	S54 and (semiconductor or wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:04

S47	13719	S46 and (semiconductor or wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:04
S56	26583	(semiconductor or wafer or substrate) and ((chamber or container or vessel) with (cylindrical or cylinder))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:07
S58	680	S57 and ((chamber or container or vessel) with (nozzle or orifice))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:08
S57	2889	S56 and ((rotat\$3 or rotary) with (hold\$3 or rotor))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:08
S60	31	S58 and (kamikawa.in. or egashira.in.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/13 15:12
S59	649	S58 NOT (kamikawa.in. or egashira.in.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/14 08:06
L3	333	semitool.as.	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:09
L4	67	3 and (clean\$3 or wash\$3 or rins\$3) with (rotor or hold\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:10
L5	67	3 and ((clean\$3 or wash\$3 or rins\$3) with (rotor or hold\$3))	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:14
L7	514	6 and rotor	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:16
L6	7811	(semiconductor or wafer or substrate) and ((cylinder or cylindrical) with (chamber or tank or vessel or bowl or container)) and (nozzle or orifice)	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:16
L8	383	7 and (wash\$3 or clean\$3 or rins\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:29

L9	109	8 and (wash\$3 or clean\$3 or rins\$3) with rotor	US-PGPUB; USPAT; USOCR	OR	ON	2004/12/14 08:30
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